

GaAs, MMIC, SPDT Switch, 10 kHz to 3 GHz

Data Sheet HMC221B

FEATURES

Low insertion loss: 0.4 dB typical Input third-order intercept (IP3): 55 dBm typical Positive control: 0 V/3 V Ultrasmall package: SOT-23

APPLICATIONS

Industrial, scientific and medical (ISM)
PCMCIA wireless cards
Cellular applications

GENERAL DESCRIPTION

The HMC221B is a single-pole, double-throw (SPDT) switch specified from 10 kHz to 3 GHz in a 6-lead SOT-23 plastic package. This switch offers a very low insertion loss of less than 0.8 dB up to 3 GHz and is well suited for receiver and filter switching applications that require low insertion loss and a small size.

The RF1 and RF2 pins are reflective shorts when in an off state, and the two control voltages (the A and B pins) require a minimal dc bias current. Note that the HMC197B exhibits a similar performance in an alternate pinout.

FUNCTIONAL BLOCK DIAGRAM

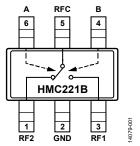


Figure 1.

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REVISION HISTORY	
12/2016—Rev. A to Rev. B	Added Table 3; Renumbered Sequentially, Interface Schematics
Changes to Ordering Guide	Section, and Figure 3 to Figure 6; Renumbered Sequentially5
	Changes to Table 45
4/2016—v01.1215 to Rev. A	Added Insertion Loss, Return Loss, and Isolation Section6
This Hittite Microwave Products data sheet has been reformatted	Added Input Power Compression and Third-Order Intercept
to meet the styles and standards of Analog Devices, Inc.	Section and Figure 10 and Figure 127
Changed SOT26 to SOT-23Throughout	Changes to Typical Application Circuit Section and Figure 158
Changes to Title, Feature Section, and General Description	Updated Outline Dimensions9
Section	Changes to Ordering Guide9
Changes to Table 1	

SPECIFICATIONS

 T_{A} = 25°C, V_{CTL} = 0 V/3 V to 8 V, 50 Ω system, unless otherwise noted.

Table 1.

Parameter	Symbol	Test Conditions/Comments	Min	Тур	Max	Unit
FREQUENCY BAND			0.01		3000	MHz
INSERTION LOSS		10 kHz to 1.0 GHz		0.4	0.7	dB
		1.0 GHz to 2.0 GHz		0.45	8.0	dB
		2.0 GHz to 2.5 GHz		0.6	0.9	dB
		2.5 GHz to 3.0 GHz		0.8	1.1	dB
Flatness		20 MHz to 1.0 GHz, maximum to minimum		0.3		dB
ISOLATION		10 kHz to 1.0 GHz	24	30		dB
		1.0 GHz to 2.0 GHz	24	29		dB
		2.0 GHz to 2.5 GHz	21	25		dB
		2.5 GHz to 3.0 GHz	14	18		dB
RETURN LOSS		10 kHz to 1.0 GHz	25	33		dB
		1.0 GHz to 2.0 GHz	20	30		dB
		2.0 GHz to 2.5 GHz	20	25		dB
		2.5 GHz to 3.0 GHz	11	22		dB
GROUP DELAY ¹		0.5 GHz to 1.0 GHz, maximum to minimum		30		ps
INPUT LINEARITY		$V_{CTL} = 0 \text{ V/5 V}$				
1 dB Power Compression	P1dB	10 kHz to 20 MHz		8 ¹		dBm
		20 MHz to 250 MHz	6	11		dBm
		250 MHz to 1.0 GHz	25	30		dBm
		1.0 GHz to 3.0 GHz	23	29		dBm
Third-Order Intercept ¹	IP3	Two-tone input power = 9 dBm/tone, $\Delta f = 1$ MHz				
		10 kHz to 10 MHz	9			dBm
		10 MHz to 20 MHz	12			dBm
		20 MHz to 30 MHz	15			dBm
		30 MHz to 250 MHz	18	26		dBm
		250 MHz to 1.0 GHz	40	55		dBm
		1.0 GHz to 3.0 GHz	38	54		dBm
SWITCHING CHARACTERISTICS ¹						
Rise and Fall Time	t _{RISE} , t _{FALL}	10% to 90% of RF output		3		ns
On and Off Time	ton, toff	50% V _{CTL} to 10%/90% of RF output		10		ns
CONTROL INPUTS		A and B pins				
Voltage ²	V CTL					
High	V _{INH}		3		8	V
Low	V _{INL}			0		V
Current	I _{CTL}					
High	I _{INH}	$V_{CTL} = 0 \text{ V}/3 \text{ V}$		0.1		μΑ
		$V_{CTL} = 0 \text{ V}/5 \text{ V}$		1		μΑ
		$V_{CTL} = 0 \text{ V/8 V}$		5		μΑ
Low	I _{INH}	$V_{CTL} = 0 \text{ V}/3 \text{ V}$		-0.1		μΑ
		$V_{CTL} = 0 \text{ V}/5 \text{ V}$		-1		μΑ
		$V_{CTL} = 0 V/8 V$		- 5		μA

 $^{^1}$ Guaranteed by design but not production tested. 2 The control input voltage tolerances are $\pm 0.2\,\text{V}$ dc.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Table 2.	
Parameter	Rating
Control Voltage Range (A and B)	–0.2 V dc to 12 V dc
RF Input Power Level (CW Peak,	0.36 W
$V_{CTL} = 0 V/5 V)$	
10 kHz to 10 MHz	8 dBm
10 MHz to 20 MHz	10 dBm
20 MHz to 30 MHz	11 dBm
30 MHz to 250 MHz	14 dBm
250 MHz to 3.0 GHz	31 dBm
Hot Switching RF Input Power Level	
(CW Peak, $V_{CTL} = 0 \text{ V}/5 \text{ V}$)	
10 kHz to 250 MHz	6 dBm
250 MHz to 3.0 GHz	20 dBm
Continuous Power Dissipation, PDISS	0.36 W
$(at T_{CASE} = 85^{\circ}C)$	
Junction to Case Thermal Resistance, Q _{JC}	178°C/W
Temperature	
Junction, T _J	150°C
Storage	−65°C to +150°C
Reflow ¹ (MSL1 Rating)	
HMC221B	235°C
HMC221BE	260°C
ESD Sensitivity	
Human Body Model (HBM)	250 V (Class 1A)

 $^{^{\}rm 1}\,\mbox{See}$ the Ordering Guide for additional information.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

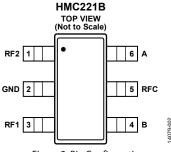


Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

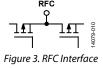
Pin No.	Mnemonic	Description
1	RF2	RF2 Port (See Figure 4). This pin is dc-coupled and matched to 50Ω . A dc blocking capacitor is required.
2	GND	Ground (See Figure 6). This pin must be connected to the RF/dc ground of the printed circuit board (PCB).
3	RF1	RF1 Port (See Figure 4). This pin is dc-coupled and matched to 50Ω . A dc blocking capacitor is required.
4	В	Control Input A (See Table 4 and Figure 5).
5	RFC	RF Common Port (See Figure 3). This pin is dc-coupled and matched to 50Ω . A dc blocking capacitor is required.
6	Α	Control Input B (See Table 4 and Figure 5).

Table 4. Truth Table

Control Input Voltage ¹		Signal Path State	
A (V dc)	B (V dc)	RFC to RF1	RFC to RF2
Low	High	On	Off
High	Low	Off	On

¹ All high or all low for control inputs, A and B, are undefined states. The switch response has a high insertion loss and poor return loss on both RF paths.

INTERFACE SCHEMATICS



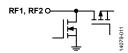


Figure 4. RF1 and RF2 Interface





TYPICAL PERFORMANCE CHARACTERISTICS

INSERTION LOSS, RETURN LOSS, AND ISOLATION

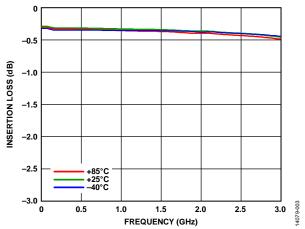


Figure 7. Insertion Loss vs. Frequency over Temperature

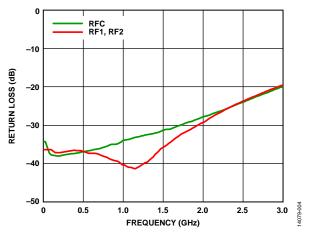


Figure 8. Return Loss vs. Frequency

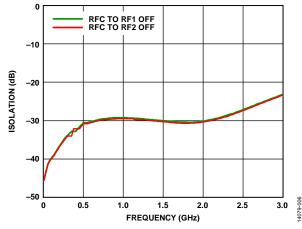


Figure 9. Isolation Between RFC and RF1/RF2 Ports vs. Frequency

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INPUT POWER COMPRESSION AND THIRD-ORDER INTERCEPT

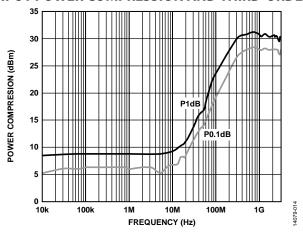


Figure 10. Input 1 dB Power Compression (P1dB) and Input 0.1dB Power Compression (P0.1dB) vs. Frequency, $V_{CTL} = 0 \text{ V/5 V}$

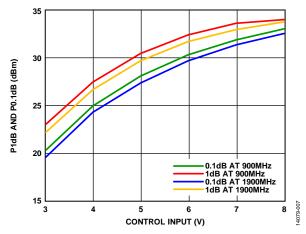


Figure 11. Input 1 dB Power Compression (P1dB) and Input 0.1dB Power Compression (P0.1dB) vs. Control Input Voltage

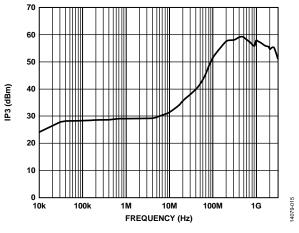


Figure 12. Input Third-Order Intercept (IP3) vs. Frequency, $V_{CTL} = 0 V/5 V$

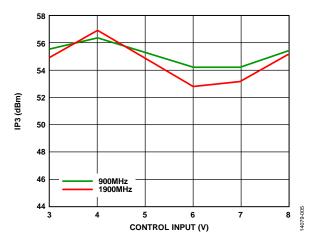
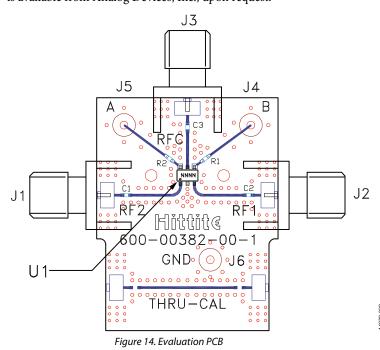


Figure 13. Input IP3 vs. Control Input Voltage

APPLICATIONS INFORMATION EVALUATION PRINTED CIRCUIT BOARD (PCB)

Generate the circuit board used in this application with proper RF circuit design techniques. Signal lines at the RF port must have 50 Ω impedance and connect the package ground leads and package bottom directly to the ground plane similar to that shown in Figure 14. The evaluation circuit board shown Figure 14 is available from Analog Devices, Inc., upon request.



TYPICAL APPLICATION CIRCUIT

Two cascaded, CMOS inverters, biased with $V_{\text{DD}} = 5$ V, can generate complementary control voltages, $V_{\text{CTL}} = 0$ V/5 V, for the A and B inputs. Therefore, the HMC221B can be controlled from a single CMOS input line (see Figure 15).

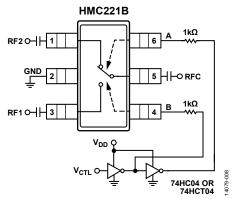


Figure 15. Typical Application Circuit

BILL OF MATERIALS

Table 5. List of Materials for Evaluation PCB EVAL01-HMC221B¹

TWO I VI ZIOV OT TIME TOT E TWANT OF E THE OFFICE OF E			
Item	Description		
J1 to J3	PCB mount SMA RF connectors		
J4 to J6	DC pins		
C1 to C3	330 pF capacitors, 0402 package		
R1, R2	1 kΩ resistors, 0402 package		
U1	HMC221BE SPDT switch		
PCB	600-00382-00-1 evaluation PCB, circuit board material: Rogers 4350		

¹ References this number when ordering the evaluation PCB.

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OUTLINE DIMENSIONS

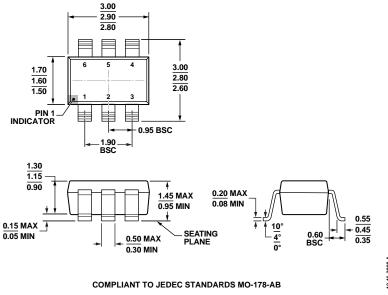


Figure 16. 6-Lead Small Outline Transistor Package [SOT-23] (RJ-6) Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature	MSL Rating ²	Description	Package Option	Branding ³
HMC221BE	-40°C to +85°C	MSL1	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	221BE
					XXXX
HMC221BETR	-40°C to +85°C	MSL1	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	221BE
					XXXX
HMC221B	-40°C to +85°C	MSL1	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	221B
					XXXX
HMC221BTR	-40°C to +85°C	MSL1	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	221B
					XXXX
EVAL01-HMC221B			Evaluation Board		

¹ The HMC221BE and the HMC221BETR are RoHS-Compliant Parts, and the HMC221B and the HMC221BTR are non RoHS-Compliant Parts.

² See the Absolute Maximum Ratings section for additional information.

³ XXXX is the 4-digit lot number.

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Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

HMC221BE HMC221BETR EVAL01-HMC221B